SDLS161 - OCTOBER 1976 - REVISED MARCH 1988

- 3-State Outputs Drive Bus Lines Directly
- Encodes 8 Data Lines to 3-Line Binary (Octal)
- Applications Include:
 N-Bit Encoding
 Code Converters and Generators
- Typical Data Delay . . . 15 ns
- Typical Power Dissipation . . . 60 mW

description

These TTL encoders feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. The 'LS348 circuits encode eight data lines to three-line (4-2-1) binary (octal). Cascading circuitry (enable input E1 and enable output E0) has been provided to allow octal expansion. Outputs A0, A1, and A2 are implemented in three-state logic for easy expansion up to 64 lines without the need for external circuitry. See Typical Application Data.

FUNCTION TABLE

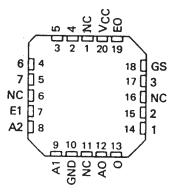
	INPUTS										JTPU	TS	
EI	0	1	2	3	4	5	6	7	A2	A1	A0	GS	EO
Н	Х	Х	Χ	Х	Χ	X	X	Х	Z	Z	Z	Н	Н
L	Н	Н	Н	Н	Н	Н	Н	Н	z	Z	Z	н	L
L	Х	Χ	Х	Х	Х	Χ	Х	L	L	L	L	L	н
L	Х	Х	Χ	Х	Х	Х	L	Н	L	L	Н	L	н
L	Х	Х	Χ	X	Х	L	Н	Н	L	Н	L	L	н
L	Х	Х	Χ	Х	L	Н	Н	Н	L	Н	Н	L	н
L	Ý	Х	Х	L	Н	Н	Н	Н	н	L	L	L	н
L	Х	Х	L	Н	Н	Н	Н	Н	н	L	н	L	н
L	Х	L	Н	H	Н	Н	Н	Н	н	Н	L	L	н
L	L	Н	Н	Н	H	Н	Н	Н	Н	Н	Н	L	н

H = high logic level, L = low logic level, X = irrelevant

SN54LS348 . . . J OR W PACKAGE SN74LS348 . . . D OR N PACKAGE (TOP VIEW)

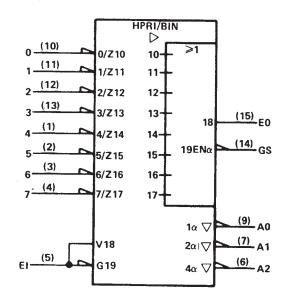
4 🛮 1	U ₁₆ V _{CC}
5 🛮 2	15 EO
6 □3	14 🛮 GS
7 🛮 4	13 3
E1 ∏5	12 2
A2 [6	11 🛮 1
A1 🔲 7	10 🛮 0
GND 🛮 8	9 AO

SN54LS348 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic symbol[†]



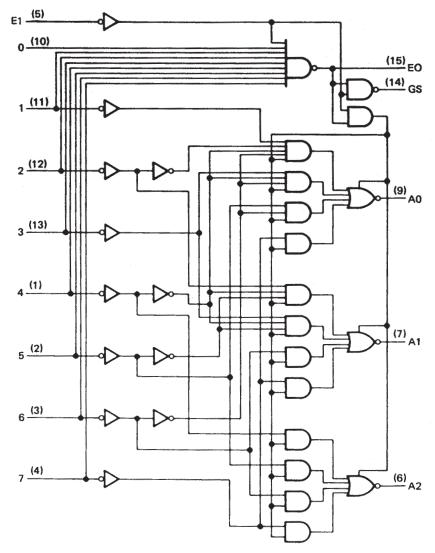
[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



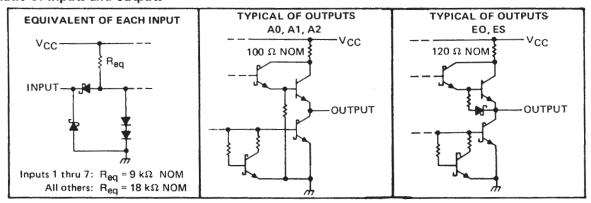
Z = high-impedance state

logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

schematic of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Operating free-air temperature range	SN54LS348
	SN74LS348
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS348			SN74LS348			
		MIN NOM MAX N				NOM MAX		UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5,25	V
High-level output current, IOH	A0, A1, A2			-1			-2.6	mA
Triginever output current, TOH	EO, GS			-400			-400	μΑ
Low-level output current, IOI	A0, A1, A2			12			24	mA
- Low-level output current, 10[EO, GS			4			8	mA
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST	SN	154LS3	148	SN74LS348			UNIT		
	TARAMETER		TEST CONDITIONS†			TYP‡	MAX	MIN	TYP‡	MAX	UNII
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage					**	0.7			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	I ₁ = -18 mA			-1.5			-1.5	V
VOH	High-level	A0, A1, A2	V _{CC} = MIN,	I _{OH} = -1 mA	2.4	3.1					
	output voltage	A0, A1, A2	V _{!H} = 2 V,	I _{OH} = -2.6 mA				2.4	3,1		V
	Output voltage	EO, GS	VIL = VILmax	$I_{OH} = -400 \mu A$	2.5	3.4		2.7 3.4			1
Voi		A0, A1, A2	V _{CC} = MIN,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
	Low-level	A0, A1, A2	V _{IH} = 2 V,	OL = 24 mA					0,35	0.5	v
	Output voltage	EO, GS	VIL = VILmax	¹ OL = 4 mA		0.25	0.4		0.25	0.4	\ \
		20, 43	VIL - VILINAX	IOL = 8 mA					0.35	0.5	
loz	Off-State (high-impedance	A0, A1, A2	V _{CC} = MAX,	V _O = 2.7 V		·········	20			20	_
.02	state) output current	A0, A1, A2	V _{IH} = 2 V	V _O = 0.4 V			-20			-20	μΑ
11	Input current at maximum	Inputs 1 thru 7	V 144.V	V 7.V			0.2			0,2	_
.1	input voltage	All other inputs	V _{CC} = MAX,	V = / V			0.1			0.1	mA
Ιн	High-level input current	Inputs 1 thru 7	V MAY	V 27V		40				40	
'1H	riigii-ievei triput current	All other inputs	V _{CC} = MAX,	V = 2.7 V			20 20		μA		
1	Low-level input current	Inputs 1 thru 7	V NAAY	V = 0 4 V			-0.8			-0.8	
HL	-ow-level input current	All other inputs	V _{CC} = MAX,	V = 0.4 V		-0.4 -0.4			-0.4	mA	
los	Short-circuit output current §	Outputs A0, A1, A2	V		-30 -130 -30			-130	<u> </u>		
.02	onore encure output current o	Outputs EO, GS	V _{CC} = MAX		-20		-100	-20		-100	mA
Icc	Supply current		V _{CC} = MAX,	Condition 1		13	25		13	25	^
.00	capping carroine		See Note 2	Condition 2		12	23		12	23	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: ICC (condition 1) is measured with inputs 7 and EI grounded, other inputs and outputs open. ICC (condition 2) is measured with all inputs and outputs open.



^{\$} All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

[§] Not more than one output should be shorted at a time.

SN54LS348, SN74LS348 (TIM9908) 8-LINE TO 3-LINE PRIORITY ENCODERS WITH 3-STATE OUTPUTS

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switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{ C}$

PARAMETER [†]	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ФLН	1 thru 7	A0, A1, or A2	In-phase		111	11	17	ns
tPHL.	1 11114 /	A0, A1, 01 A2	output	C. = 45 = 5		20	30	112
ФLН	1 thru 7	A0, A1, or A2	Out-of-phase	C _L ≈ 45 pF,		23	35	ns
tPHL	1 thru /	AU, A1, 01 A2	output	R _L = 667 Ω, See Note 3		23	35	113
ФZН	Et	A0, A1, or A2		See 14016 2		25	39	ns
ΨZL] '	70, 71, 01 72				24	41] ""
tPLH	0 thru 7	EO	Out-of-phase			11	18	ns
tPHL	o and /		output			26.	40	
tPLH	0 thru 7	GS	In-phase	Cլ = 15 pF		38	55	ns
tPHL	O and /		output	$R_{L} = 2 k\Omega$,		9	21	1 ""
tPLH	EI	GS	In-phase	See Note 3		11	17	
tPHL	1 -	43	output	See Note 3		14	36	ns
ФLН	EI	EO	In-phase			17	26	
tPHL	1 "		output	:		25	40	ns
^t PHZ	EI	A0, A1, or A2		CL = 5 pF		18	27	
tPLZ] -'	70, 71, 01 72		R _L = 667 Ω		23	35	ns

 $^{^{\}dagger}$ tpLH = propagation delay time, low-to-high-level output

tpzH = output enable time to high level

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TYPICAL APPLICATION DATA

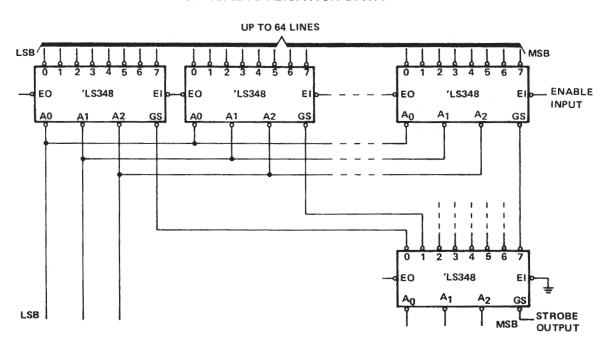


FIGURE 1-PRIORITY ENCODER WITH UP TO 64 INPUTS.



tpHL = propagation delay time, high-to-low-level output



PACKAGE OPTION ADDENDUM

24-Aug-2018

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS348D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS348	Samples
SN74LS348N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS348N	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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24-Aug-2018

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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